

Date:- 24 Jun, 2004

Data Sheet Issue:-1

Provisional Data

Rectifier Diode

Types W5292T#500 to W5292T#560

Development Type No.: WX043TC500-560-

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{RRM}	Repetitive peak reverse voltage, (note 1)	5000-5600	V
V _{RSM}	Non-repetitive peak reverse voltage, (note 1)	5100-5700	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{F(AV)M}	Maximum average forward current, T _{sink} =55°C, (note 2)	5292	А
I _{F(AV)M}	Maximum average forward current. T _{sink} =100°C, (note 2)	3680	А
I _{F(AV)M}	Maximum average forward current. T _{sink} ≠100°C, (note 3)	2271	А
I _{F(RMS)M}	Nominal RMS forward current, T _{sink} =25°C, (note 2)	9724	А
I _{F(d.c.)}	D.C. forward current, T _{sink} =25°C, (note 4)	8543	А
I _{FSM}	Peak non-repetitive surge $t_p=10 \text{ ms}, \forall r_m=60\% V_{\text{RRM}}$, (note 5)	52.7	kA
I _{FSM2}	Peak non-repetitive surge t _p =/10ms, V _{rm} ≤10V, (note 5)	58.0	kA
l ² t	I^{2} t capacity for fusing t _p =10ms, $V_{mq}=60\%V_{RRM}$, (note 5)	13.9×10 ⁶	A ² s
l ² t	I^{2} t capacity for fusing t _p =10ms, V _{tm} ≤10V, (note 5)	16.8×10 ⁶	A ² s
T _{j op}	Operating temperature range	-40 to +160	°C
T _{stg}	Storage temperature range	-55 to +160	°C

Notes:-

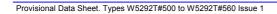
1) De-rating factor of 0.13% per $^{\circ}$ C is applicable for T_j below 25°C.

2) Double side cooled, single phase; 50Hz, 180° half-sinewave.

3) Single side cooled, single phase; 50Hz, 180° half-sinewave.

4) Double side cooled.

5) Half-sinewave, 160°C T_j initial.



Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V _{FM}	Maximum peak forward voltage	-	-	1.70	I _{TM} =6000A	V
V _{FM}	Maximum peak forward voltage	-	-	2.79	I _{TM} =15900A	V
V _{T0}	Threshold voltage	-	-	1.027		V
r⊤	Slope resistance	-	-	0.111		mΩ
I _{RRM}	Peak reverse current	-	-	200	Rated V _{RRM}	mA
I _{RRM}	Peak reverse current	-	-	30	Rated V _{RRM} , $\vec{Y}_j=25^{\circ}C$	mA
Q _{rr}	Recovered charge	-	18000	- /		μC
Q _{ra}	Recovered charge, 50% Chord	-	12000	14000	/ _{TM} =4000A, t _p =2000µs, di/dt=10A/µs,	μC
Irr	Reverse recovery current	-	360		Vr=100V	Α
trr	Reverse recovery time	-	68	-		μs
D		-	-	0.008	Double side cooled	K/W
R _{thJK}	Thermal resistance, junction to heatsink	-	-	0.016	Single side cooled	K/W
F	Mounting force	63	- /	_77_		kN
14/) M/-:	-	1.23	$\overline{}$	Qutline Options TC and TT	1
Wt	Weight	-	1.70	///	Outline Options TD and TV	kg

Notes:-

- 1) Unless otherwise indicated $T_i=160^{\circ}C$.
- 2) For other clamp forces, please consult factory.

Notes on rupture rated packages. This product is available with a non-rupture rated package. For additional details on these products, please consult factory.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

1.0 Vollage Grade Table			
Voltage Grade	V _{RRM} V	V _{RSM} V	
50	5000	5100	2200
52	5200	5300	2240
54	5400	5500	2280
56	5600	5700	2320

2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_ibelow 25°C.

4.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

 $W_{AV} = \frac{\Delta T}{R_{th}}$

 $\Delta T = T_{j \max} - T_K$

5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^{2} + 4 \cdot ff^{2} \cdot r_{P} \cdot W_{AV}}}{2 \cdot ff^{2} \cdot r_{T}} \text{ and:}$$

Where
$$V_{T0}$$
=1.027V, r_T=0.111m Ω ,

 R_{th} = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance						
Conduction Angle	6 phase (60°)	3 phase (120°)	¹ ⁄ ₂ wave (180°)	d.c.		
Square wave Double Side Cooled	0.00907	0.00891	0.00878	0.008		
Square wave Single Side Gooled	0.01781	0.01759	0.01731	0.016		
Sine wave Double Side Cooled	0.00903	0.00884	0.00867			
Sine wave Single Side Cooled	0.01775	0.01735	0.01682			
		•				

Form Factors						
Conduction Angle	6 phase (60°)	3 phase (120°)	¹ ⁄ ₂ wave (180°)	d.c.		
Square wave	2.449	1.732	1.414	1		
Sine wave	2.778	1.879	1.57			

5.2 Calculating V_F using ABCD Coefficients

The on-state characteristic I_F vs. V_F, on page 6 is represented in two ways;

- (i) the well established V_{T0} and r_T tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_F in terms of I_F given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for V_F agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients	160°C Coefficients
А	0.61079656	0.615582755
В	0.0234119	-0.02994657
С	6.6199×10 ⁻⁵	6.917×10 ^{-5∕}
D	3.72241×10 ⁻³	0.01174699

5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}} \right)$$

Where p = 1 to *n*, *n* is the number of terms in the series and:

- t = Duration of heating pulse in seconds.
- $r_t =$ Thermal resistance at time t.
- r_p = Amplitude of p_{th} term.
- τ_p = Time Constant of r_{th} term.

The coefficients for this device are shown in the tables below:

D.C. Single Side Cooled							
Term	1	2	3	4			
r _p	0.01551	2.7827×10 ⁻³	4.2105×10 ⁻³	9.443×10 ⁻⁴			
τρ	10.04275	1.783567	0.2231307	3.428×10 ⁻³			

D.C. Double Side Coøled							
Term	1	2	$ \langle 3 \rangle $	4	5		
r _p	6.4176×10⁻³	2.7472×10 ⁻³	1/2515×10 ⁻³	0.6336×10⁻³	0.59597×10 ⁻³		
τρ	1.785337	0.34595	0.099651	0.014214	2.298151×10 ⁻³		

6.0 Reverse recovery ratings

(i) Q_{ra} is based on 50% I_m chord as shown in Fig. 1

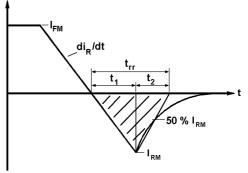


Fig. 1

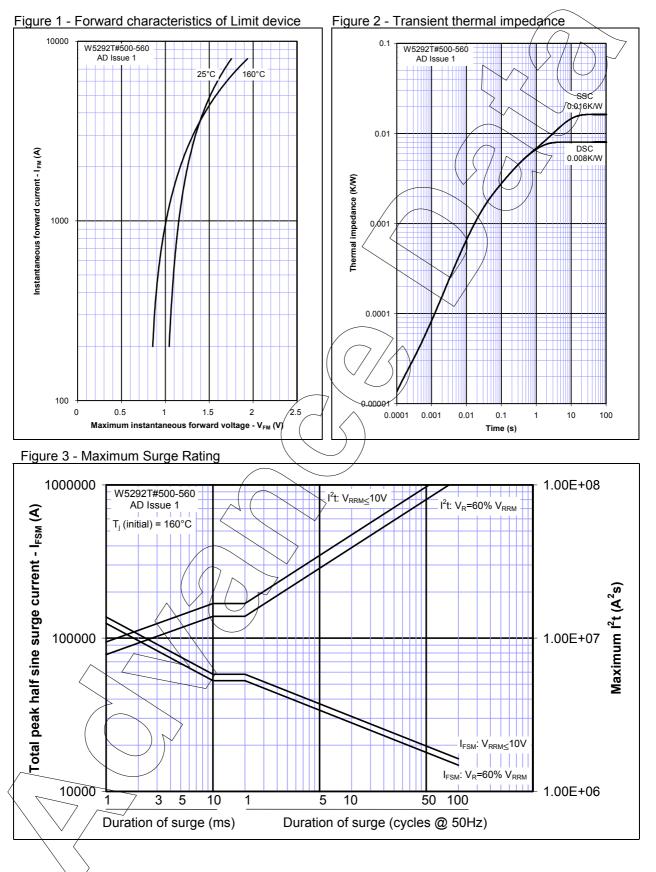
(ii) Q_{rr} is based on a 150µs integration time i.e.

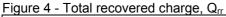
 $Q_{rr} = \int_{0}^{150\,\mu s} i_{rr}.dt$

(iii)

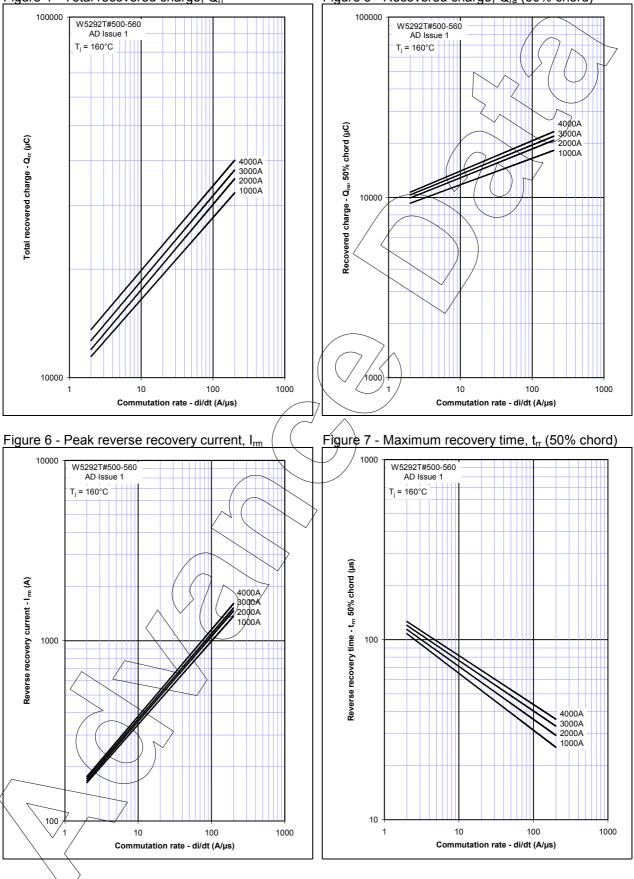
$$K Factor = \frac{t_1}{t_2}$$

<u>Curves</u>









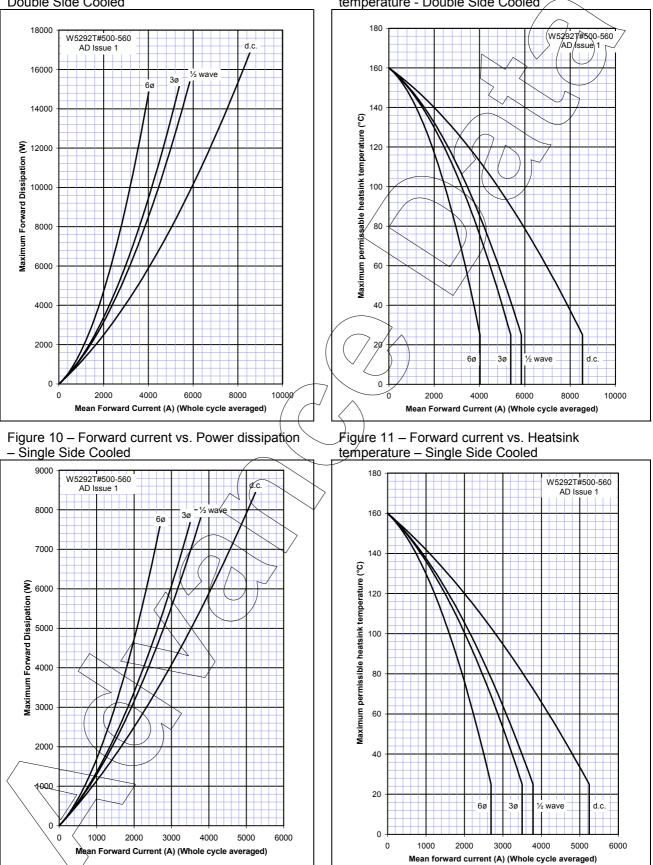


Figure 8 – Forward current vs. Power dissipation – Double Side Cooled

Figure 9 – Forward current vs. Heatsink temperature - Double Side Cooled

Outline Drawing & Ordering Information

